

RD Number: RD141

RD Title: TC78S600FTG Evaluation circuit BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	C_OSC	1	220pF 100V	—	—	Chip capacitor		
2	C_Vcc1	1	10μF 16V	—	—	Electrolytic capacitor		
3	C_Vcc2	1	0.1μF 100V	—	—	Chip capacitor		
4	C_VM1	1	47μF 50V	—	—	Electrolytic capacitor		
5	C_VM2	1	0.1μF 100V	—	—	Ceramic capacitor		
6	C_Vref	1	0.1μF 100V	—	—	Chip capacitor		
7	C_AO1	0	1000pF	—	—	Chip capacitor		✓
8	C_AO2	0	1000pF	—	—	Chip capacitor		✓
9	C_BO1	0	1000pF	—	—	Chip capacitor		✓
10	C_BO2	0	1000pF	—	—	Chip capacitor		✓
11	C_TQ	0	0.1μF 100V	—	—	Chip capacitor		✓
12	C_ENABLE	0	0.1μF 100V	—	—	Chip capacitor		✓
13	C_CK	0	0.1μF 100V	—	—	Chip capacitor		✓
14	C_M1	0	0.1μF 100V	—	—	Chip capacitor		✓
15	C_M2	0	0.1μF 100V	—	—	Chip capacitor		✓
16	C_CW/CCW	0	0.1μF 100V	—	—	Chip capacitor		✓
17	R_RFA	1	0.51Ω 0.5W	—	—	Chip resistor		
18	R_RFB	1	0.51Ω 0.5W	—	—	Chip resistor		
19	R_MO	1	100kΩ 0.25W	—	—	Chip resistor		
20	CON1	1	Connector 4P	—	—	Connector 4P-2.5		
21	CON2	0	Connector 2P	—	—	Connector 2P-2.5		✓
22	CON3	0	Connector 2P	—	—	Connector 2P-2.5		✓
23	VM	1	Check terminal	—	—	Check pin		
24	Vcc	1	Check terminal	—	—	Check pin		
25	Vref	1	Check terminal	—	—	Check pin		
26	/RESET	1	Check terminal	—	—	Check pin		

27	/MO	1	Check terminal	–	–	Check pin		
28	TQ	1	Check terminal	–	–	Check pin		
29	ENABLE	1	Check terminal	–	–	Check pin		
30	CK	1	Check terminal	–	–	Check pin		
31	/STBY	1	Check terminal	–	–	Check pin		
32	M1	1	Check terminal	–	–	Check pin		
33	M2	1	Check terminal	–	–	Check pin		
34	CW/CCW	1	Check terminal	–	–	Check pin		
35	OSC	1	Check terminal	–	–	Check pin		
36	AO1	1	Check terminal	–	–	Check pin		
37	AO2	1	Check terminal	–	–	Check pin		
38	BO1	1	Check terminal	–	–	Check pin		
39	BO2	1	Check terminal	–	–	Check pin		
40	GND1	1	Check terminal	–	–	Check pin		
41	GND2	1	Check terminal	–	–	Check pin		
42	GND3	1	Check terminal	–	–	Check pin		
43	GND4	1	Check terminal	–	–	Check pin		
44	GND5	1	Check terminal	–	–	Check pin		
45	GND6	1	Check terminal	–	–	Check pin		
46	GND	1	Check terminal	–	–	Check pin		
47	SW2(ENABLE)	1	Pin header 3P	–	–	Jumper		
48		1	Jumper socket	–	–	Short pin		
49	SW3(CK)	0	Pin header 3P	–	–	Jumper		✓
50		0	Jumper socket	–	–	Short pin		✓
51	SW6(/STBY)	1	Pin header 3P	–	–	Jumper		
52		1	Jumper socket	–	–	Short pin		
53	SW8(M1)	1	Pin header 3P	–	–	Jumper		
54		1	Jumper socket	–	–	Short pin		
55	SW9(M2)	1	Pin header 3P	–	–	Jumper		
56		1	Jumper socket	–	–	Short pin		
57	SW12(CW/CCW)	1	Pin header 3P	–	–	Jumper		
58		1	Jumper socket	–	–	Short pin		
59	SW19(/RESET)	1	Pin header 3P	–	–	Jumper		
60		1	Jumper socket	–	–	Short pin		



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